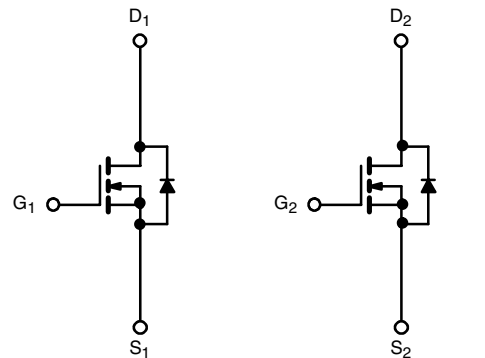
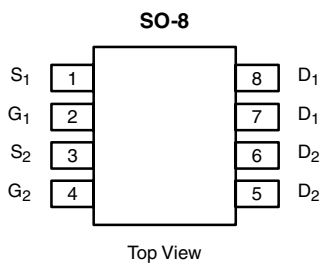


Dual N-Channel 75-V (D-S) MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
75	0.048 at $V_{GS} = 10$ V	4.8
	0.062 at $V_{GS} = 4.5$ V	4.2

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- 175 °C Maximum Junction Temperature
- High-Efficiency PWM Optimized
- Compliant to RoHS Directive 2002/95/EC



Ordering Information: Si4992EY-T1-E3 (Lead (Pb)-free)
Si4992EY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted					
Parameter	Symbol	10 s	Steady State	Unit	
Drain-Source Voltage	V_{DS}	75		V	
Gate-Source Voltage	V_{GS}	± 20			
Continuous Drain Current ($T_J = 175$ °C) ^a	I_D	$T_A = 25$ °C	4.8	3.6	A
		$T_A = 85$ °C	3.7	2.8	
Continuous Source Current ^a	I_S	2	1.1		
Pulsed Drain Current	I_{DM}	20			
Avalanche Current	I_{AS}	8		mJ	
Single Avalanche Energy (Duty Cycle ≤ 1 %)	E_{AS}	3.2			
Maximum Power Dissipation ^a	P_D	$T_A = 25$ °C	2.4	1.4	W
		$T_A = 85$ °C	1.4	0.8	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 175		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R_{thJA}	$t \leq 10$ s	50	62.5	°C/W
		Steady State	85	110	
Maximum Junction-to-Foot (Drain)	R_{thJF}	31	37		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

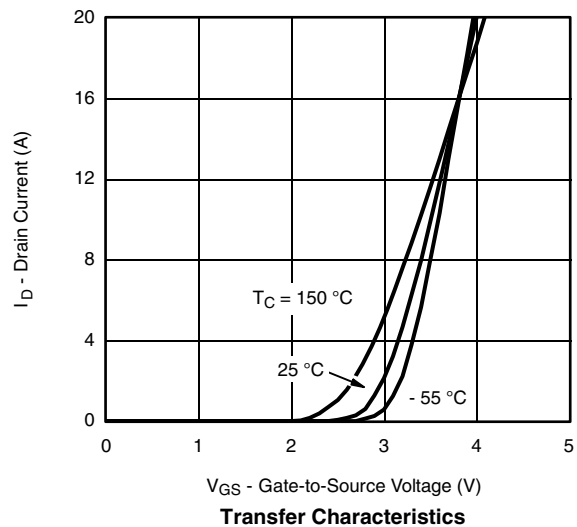
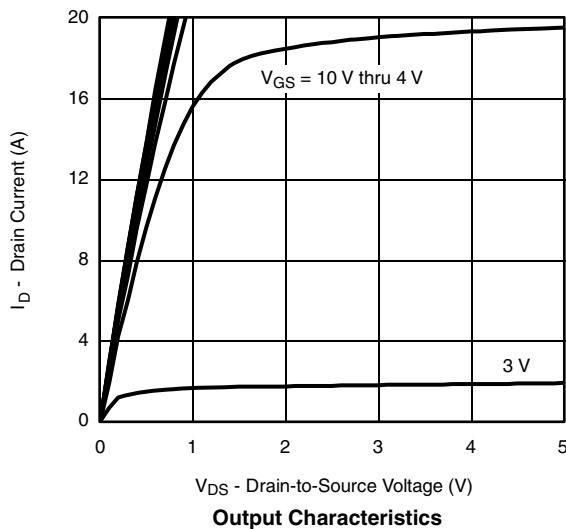
SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1		3	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85^\circ\text{C}$			20	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 10 \text{ V}, I_D = 4.8 \text{ A}$		0.039	0.048	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$		0.050	0.062	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 4.8 \text{ A}$		16		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.4 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 38 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.8 \text{ A}$		14	21	nC
Gate-Source Charge	Q_{gs}			2.4		
Gate-Drain Charge	Q_{gd}			3.5		
Gate Resistance	R_g	$f = 1 \text{ MHz}$		3.6		Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 38 \text{ V}, R_L = 38 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		7	15	ns
Rise Time	t_r			10	15	
Turn-Off Delay Time	$t_{d(off)}$			22	35	
Fall Time	t_f			10	15	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 2.4 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$		25	50	

Notes:

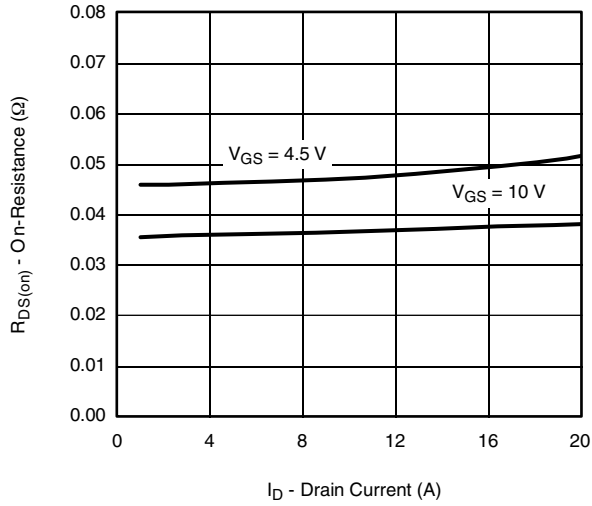
- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

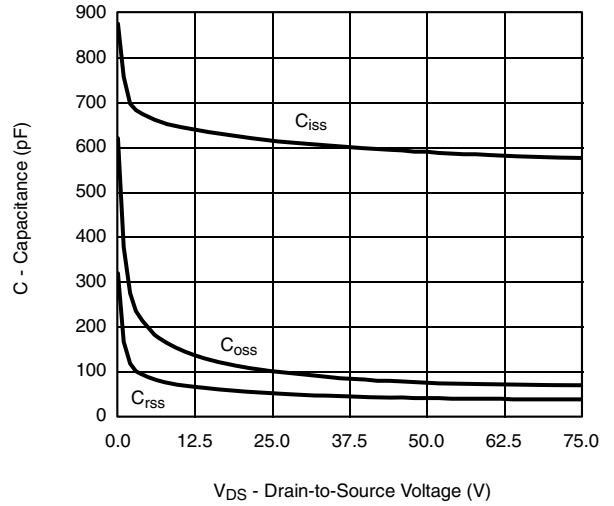
TYPICAL CHARACTERISTICS 25°C , unless otherwise noted



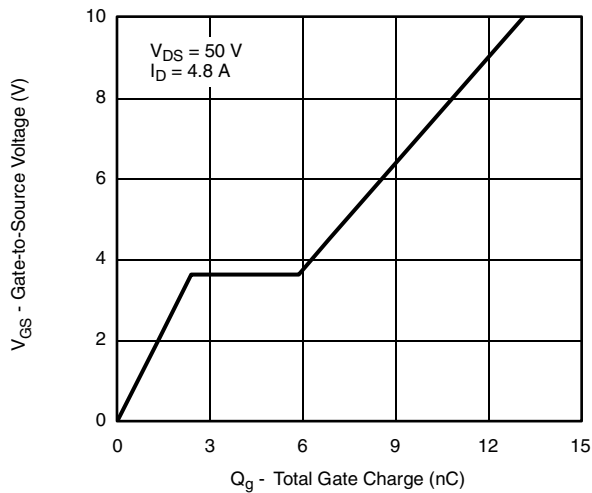
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



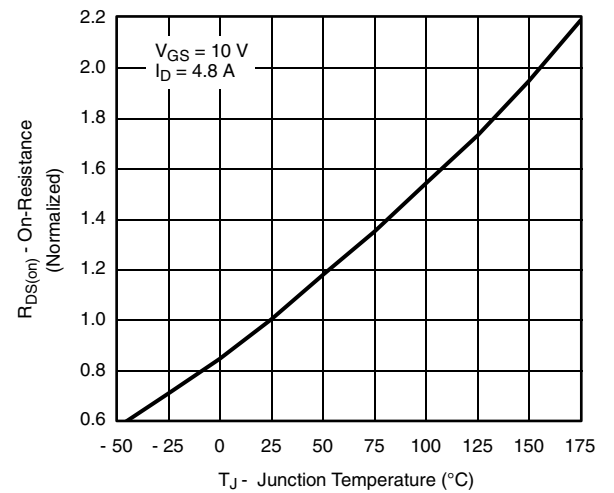
On-Resistance vs. Drain Current



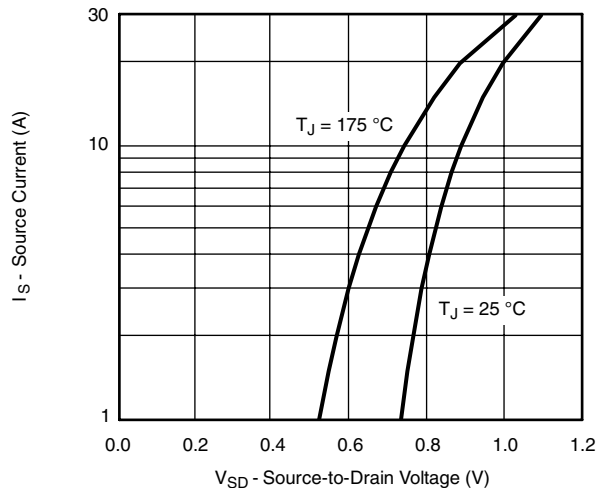
Capacitance



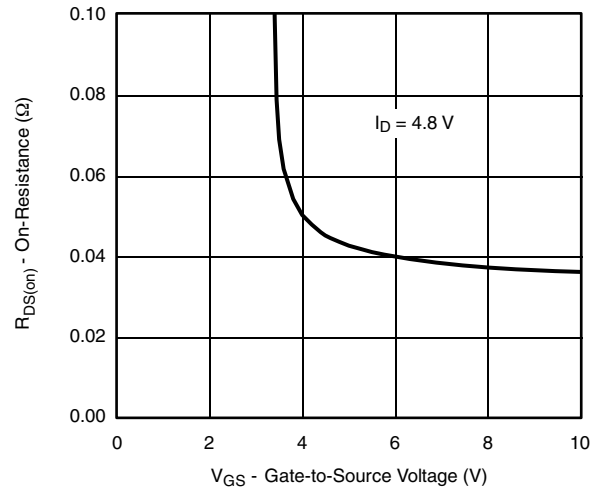
Gate Charge



On-Resistance vs. Junction Temperature

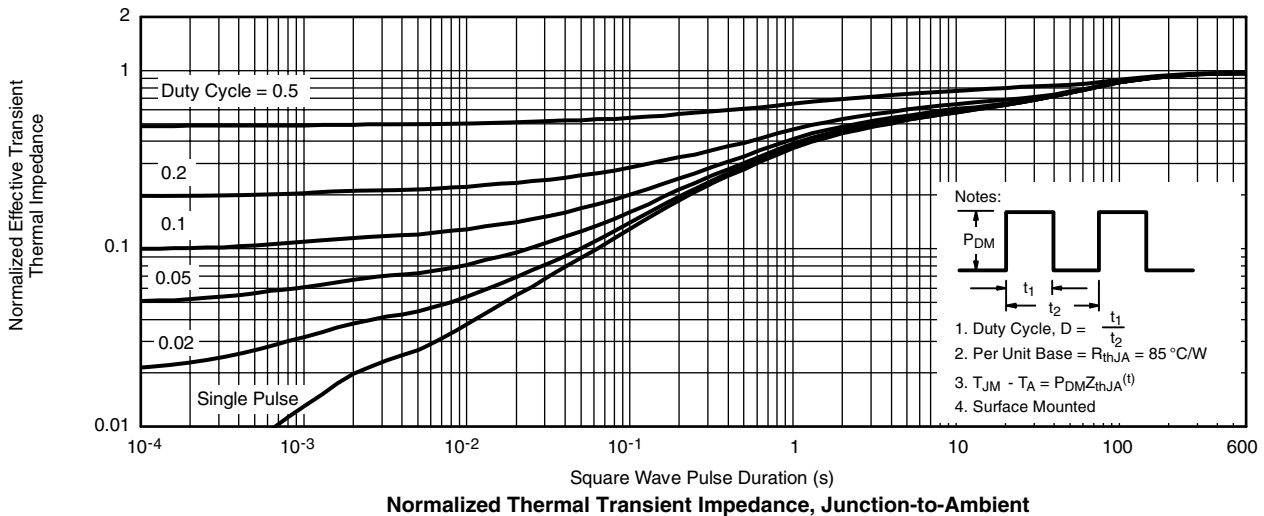
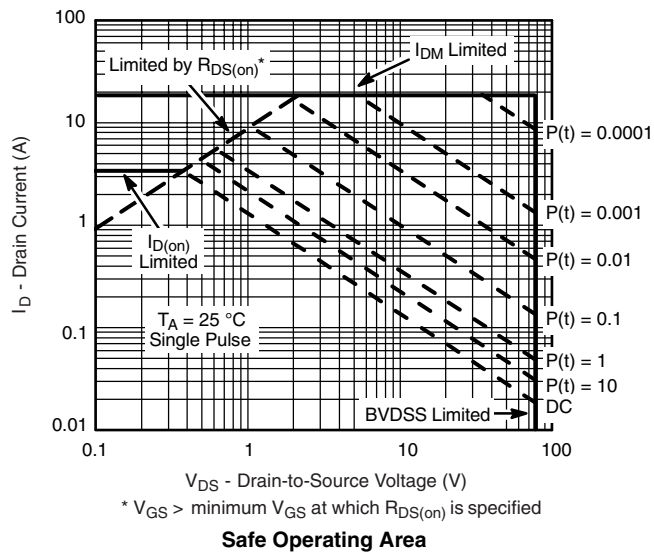
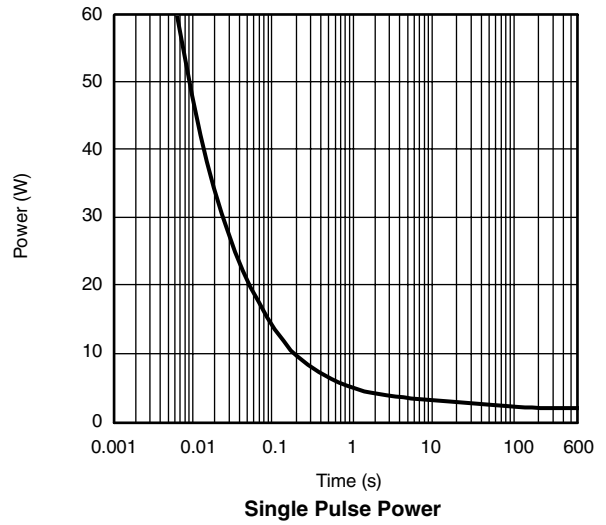
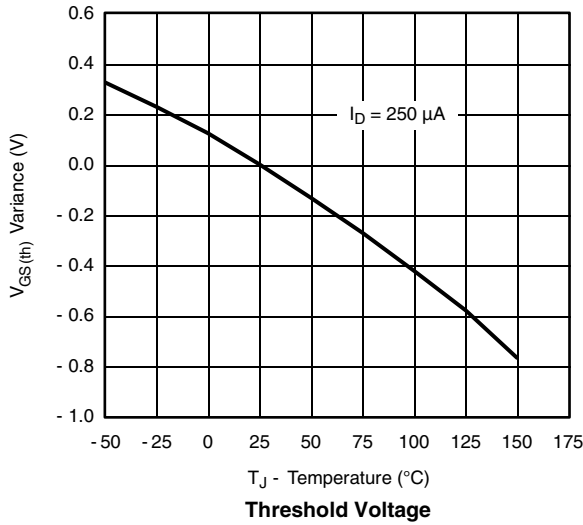


Source-Drain Diode Forward Voltage

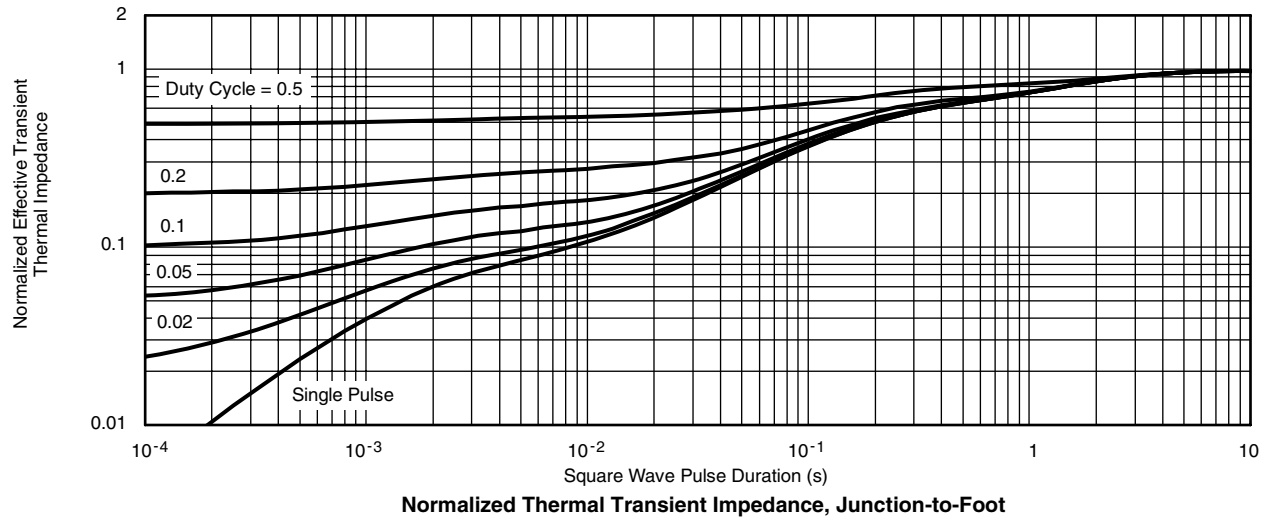


On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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